SMALL SIGNAL COMPLEMENTARY PRE-BIASED DUAL TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- Surface Mount Package Suited for Automated Assembly
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

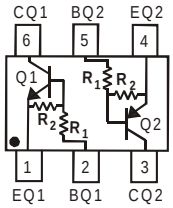
R_1 (Nom)	R_2 (Nom)
22kΩ	22kΩ

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.006 grams (Approximate)

SOT363

Top View



Device Schematic

Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ACX124EUQ-7R	Automotive	1Y3	7	8	3,000
ACX124EUQ-13R	Automotive	1Y3	13	8	10,000

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.
5. -13R are parts rotated in the pocket tape by +180°. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

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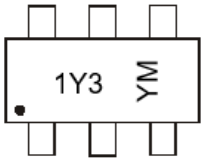


1Y3 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: E = 2017)
M = Month (ex: 9 = September)

Date Code Key

Year	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	D	E	F	G	H	I	J	K	L	M	N

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Absolute Maximum Ratings - NPN Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <Pin: (6) to (1)>	V_{CC}	50	V
Input Voltage <Pin: (2) to (1)>	V_{IN}	-10 to +40	V
Output Current	I_O	30	mA
Output Current	I_C (Max)	100	mA

Absolute Maximum Ratings - PNP Section (@T_A = +25°C, unless otherwise specified.)

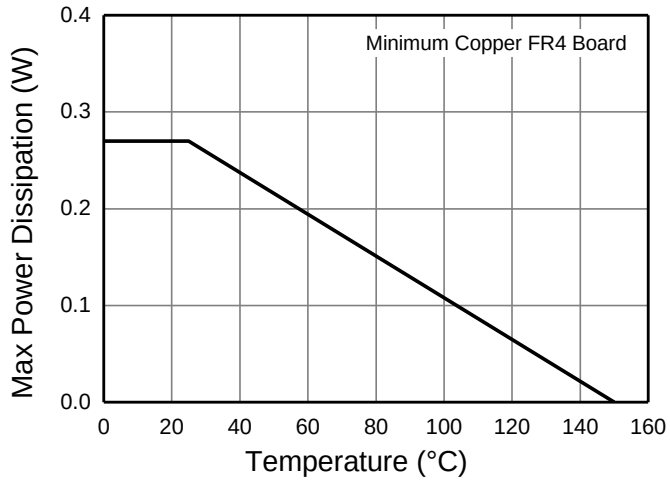
Characteristic	Symbol	Value	Unit
Supply Voltage <Pin: (4) to (3)>	V_{CC}	50	V
Input Voltage <Pin: (5) to (4)>	V_{IN}	+10 to -40	V
Output Current	I_O	-30	mA
Output Current	I_C (Max)	-100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

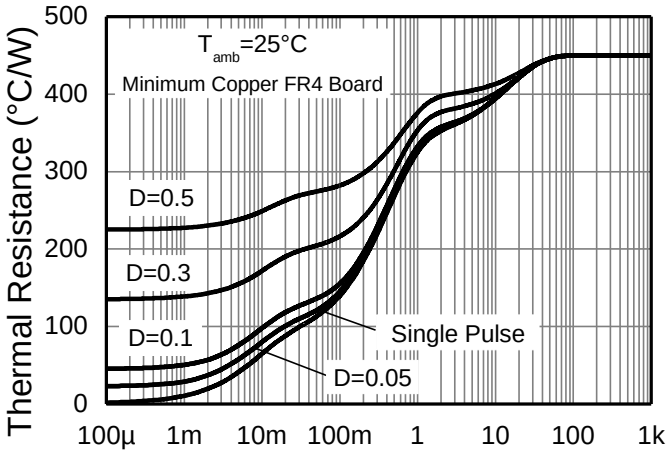
Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 6 & 7)	P_D	270	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\theta JA}$	450	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Notes: 6. Mounted on FR4 PC Board with minimum recommended pad layout
7. 150mW per element must not be exceeded.

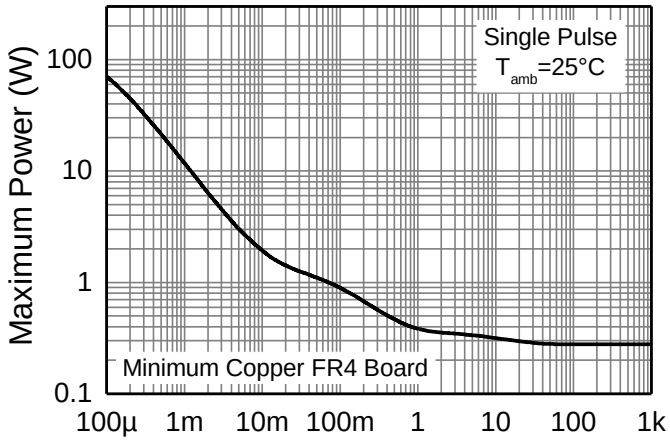
Thermal Characteristics and Derating Information



Derating Curve



Transient Thermal Impedance



Pulse Power Dissipation

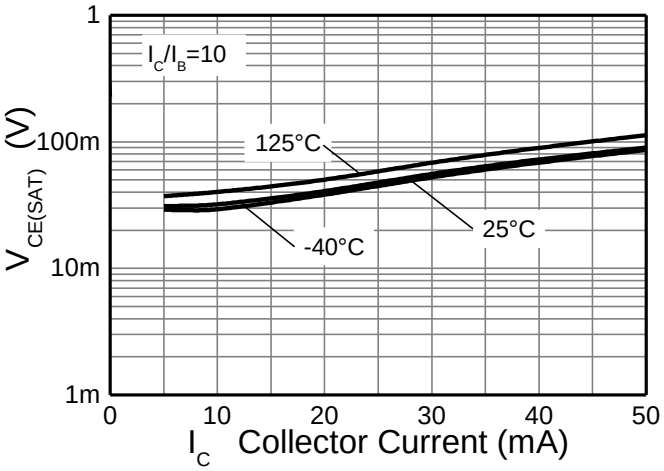
Electrical Characteristics - NPN Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(OFF)}$	0.5	1.1	—	V	V_{CC} = 5V, I_O = 100µA
	$V_{I(ON)}$	—	1.9	3.0		V_O = 0.3V, I_O = 5mA
Output Voltage	$V_{O(ON)}$	—	0.1	0.3	V	I_O/I_I = 10mA / 0.5mA
Input Current	I_I	—	—	0.36	mA	V_I = 5V
Output Current	$I_{O(OFF)}$	—	—	0.5	µA	V_{CC} = 50V, V_I = 0V
DC Current Gain	G_I	60	—	—	—	V_O = 5V, I_O = 5mA
Input Resistor (R_1) Tolerance	ΔR_1	-30	—	+30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	—	+20	%	—
Gain-Bandwidth Product	f_T	—	250	—	MHz	V_{CE} = 10V, I_E = 5mA, f = 100MHz

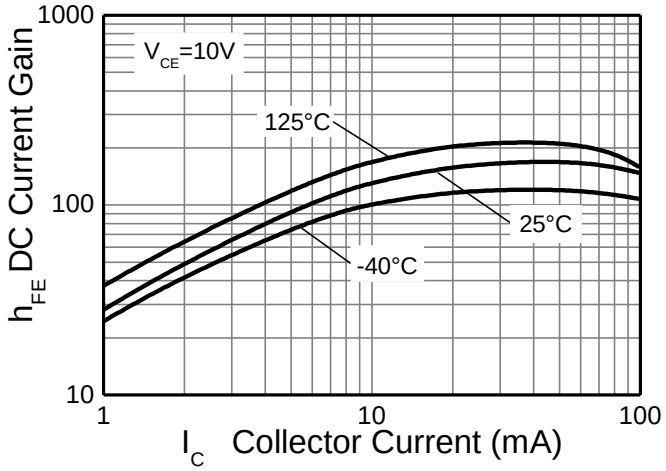
Electrical Characteristics - PNP Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(OFF)}$	-0.5	-1.1	—	V	V_{CC} = -5V, I_O = -100µA
	$V_{I(ON)}$	—	-1.9	-3.0		V_O = -0.3V, I_O = -5mA
Output Voltage	$V_{O(ON)}$	—	-0.1	-0.3	V	I_O/I_I = -10mA / -0.5mA
Input Current	I_I	—	—	-0.36	mA	V_I = -5V
Output Current	$I_{O(OFF)}$	—	—	-0.5	µA	V_{CC} = 50V, V_I = 0V
DC Current Gain	G_I	60	—	—	—	V_O = -5V, I_O = -5mA
Input Resistor (R_1) Tolerance	ΔR_1	-30	—	+30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	—	+20	%	—
Gain-Bandwidth Product	f_T	—	250	—	MHz	V_{CE} = -10V, I_E = -5mA, f = 100MHz

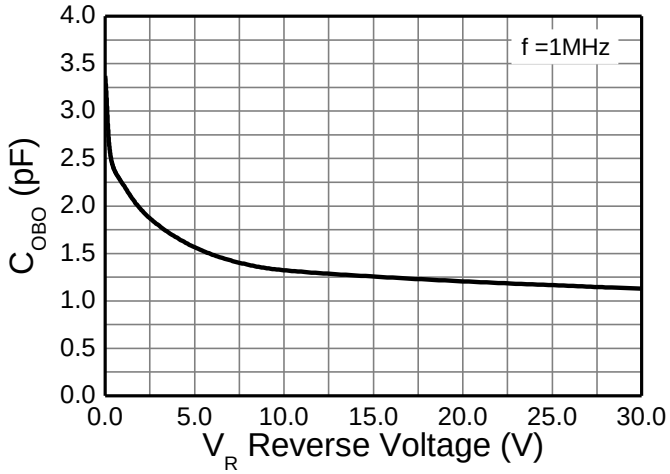
Typical Electrical Characteristics – NPN Section (@T_A = +25°C, unless otherwise specified.)



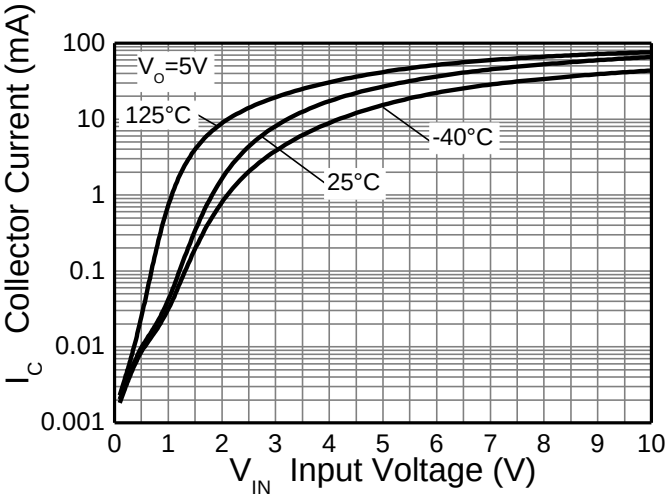
$V_{CE(SAT)}$ v Collector Current



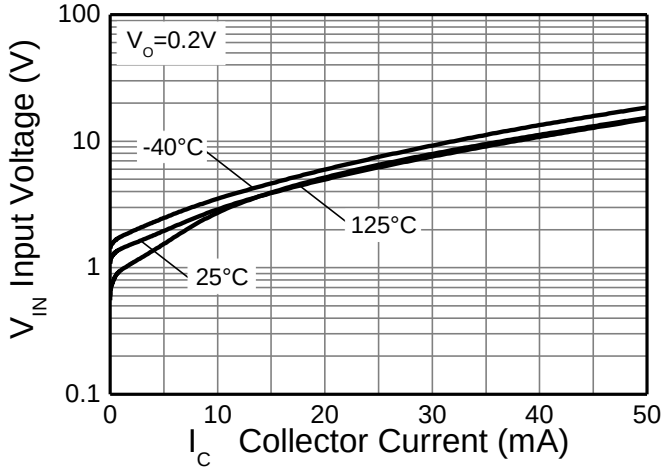
h_{FE} v Collector Current



Output Capacitance

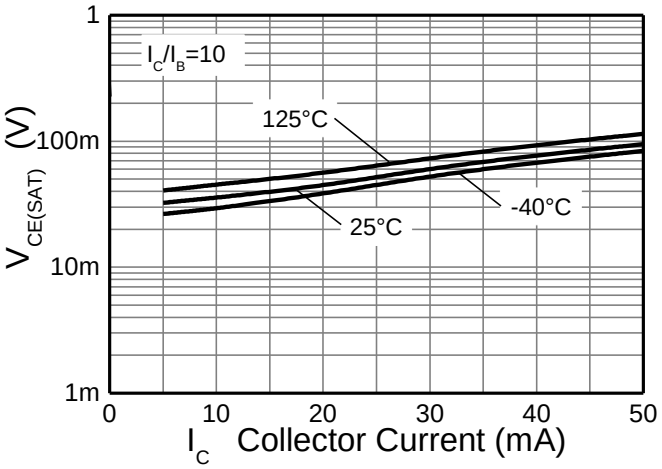


Collector Current v Input Voltage

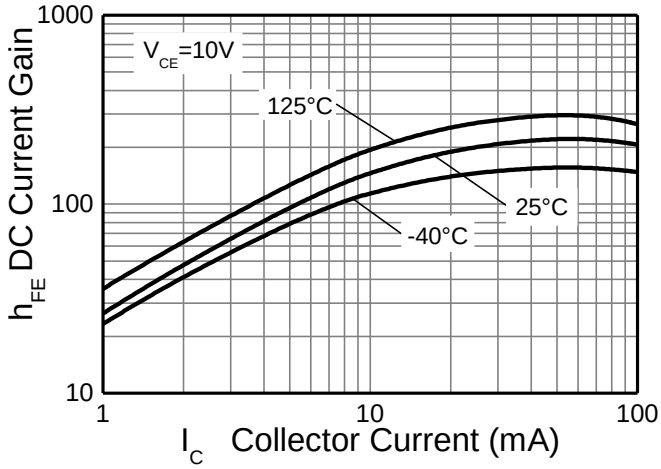


Input Voltage v Collector Current

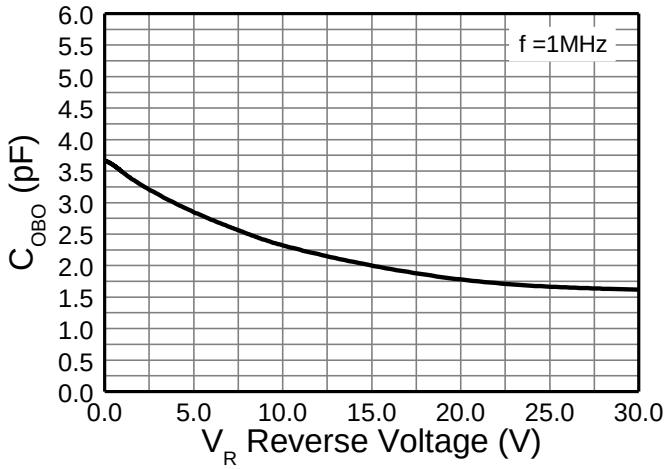
Typical Electrical Characteristics – PNP Section (@T_A = +25°C, unless otherwise specified.)



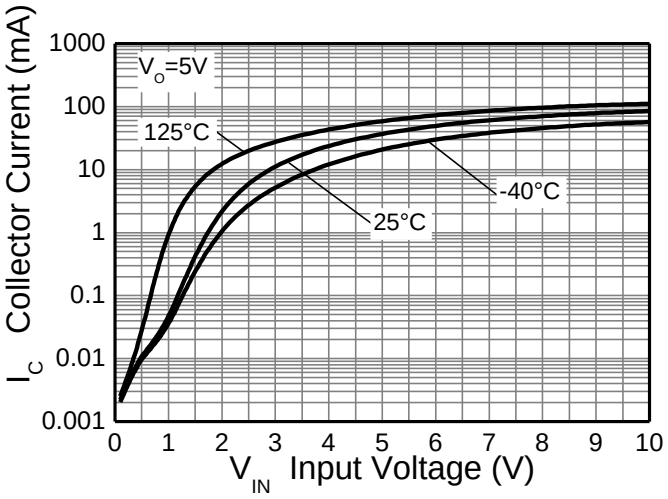
$V_{CE(SAT)}$ v Collector Current



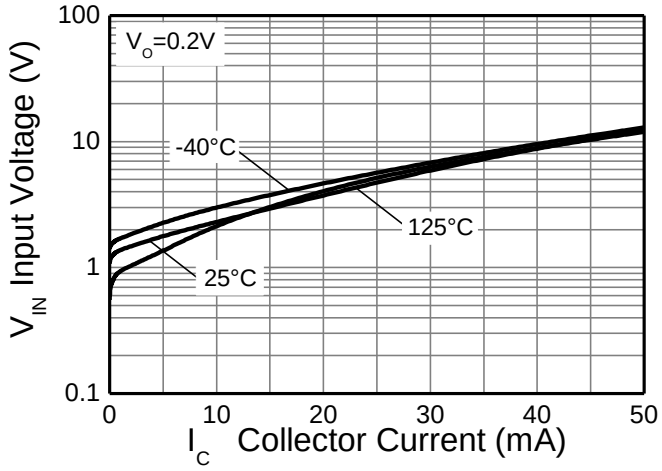
h_{FE} v Collector Current



Output Capacitance



Collector Current v Input Voltage



Input Voltage v Collector Current

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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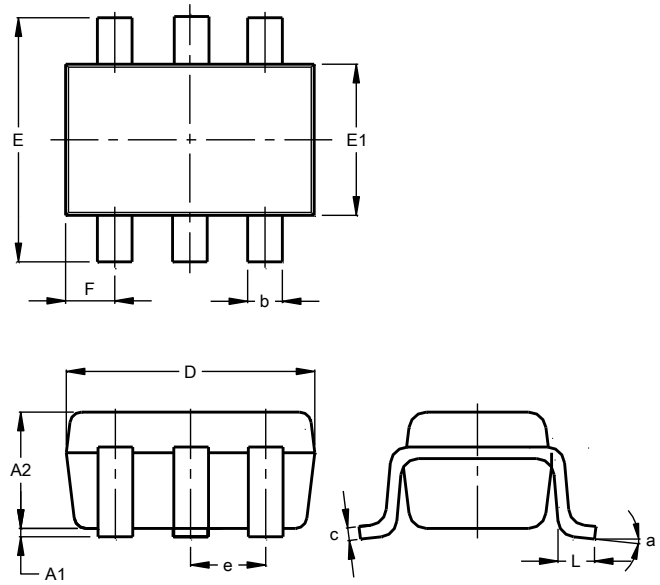

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Dim	**Min**	**Max**	**Typ**
A1	0.00	0.10	0.05
A2	0.90	1.00	1.00
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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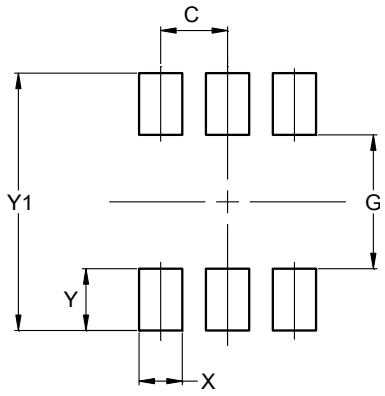

Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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